



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



HEAT DISSIPATOR

| PART NO. | MAT'L NO. | MAT'L (REF) | ALT MAT'L |
|-----------|-----------|-------------|-----------|
| RUR671-2U | 101-105 | BERY. COP. | RUR671U |
| RUR671-2U | 102-019 | BRASS | RUR671U |

01-0109
ON '9MG

REVISIONS

| SYM | DESCRIPTION | DATE | APPROVAL |
|-----|--------------------------|--------|----------|
| A | PRODUCTION RELEASE | 3-4-74 | |
| B | .113 \pm .005 WAS .113 | 3-9-76 | |
| C | REVISED PER E.O. #1283 | 3/2/83 | |

COPY
NO. 15

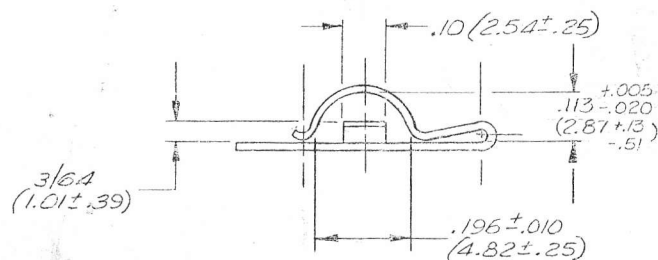
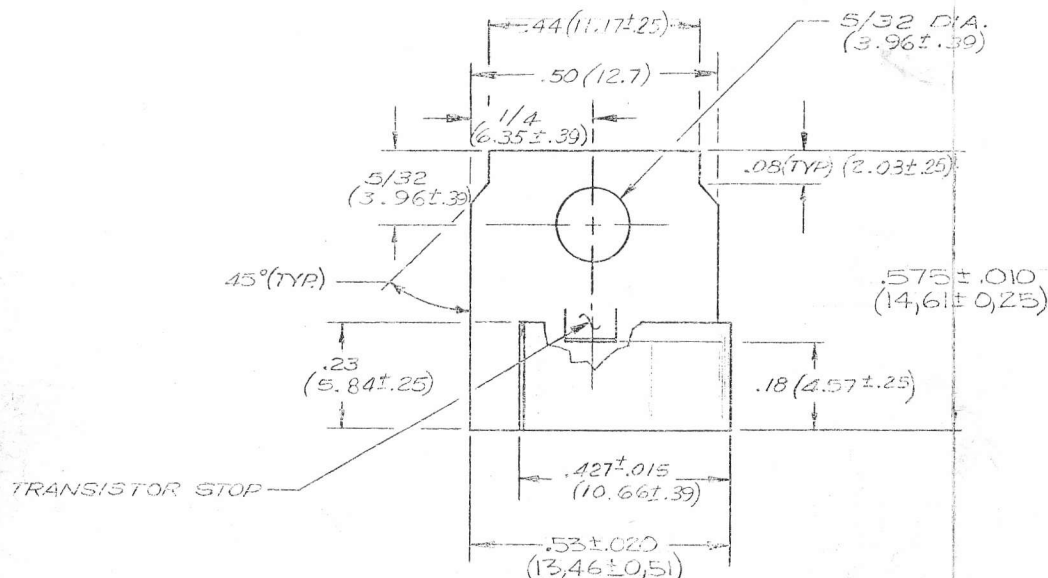
NOTES:

① STANDARD PART IS UNPLATED.

ALTERNATE FINISHES:

- a) BLACK CAD PLATE PER IERC SPEC 22101
TYPE II, CLASS 2. DELETE SUFFIX "U" & ADD
"B" TO PART NO. (EX: RUR671-2B)
- b) BLACK CHEMICAL OXIDE: DELETE SUFFIX "U"
& ADD "CB" TO PART NO. (EX: RUR671-2CB)


② HEAT TREAT PER IERC SPEC 22205 METHOD A.

3. ALL DIMENSIONS IN PARENTHESES ARE
IN MILLIMETERS.

UNLESS OTHERWISE SPECIFIED —

DIMENSIONS APPLY AFTER PLATING
TOLERANCES

| | | | |
|--------|-----------------|-----------------|---------|
| FRAC. | $\pm 1/64$ | .XX \pm .010 | SURFACE |
| ANGLES | $\pm 1/2^\circ$ | .XXX \pm .005 | |

| HEAT DISSIPATOR | — | — | .012 THK. BRASS COMP 2 1/2 HARD | ① |
|------------------------|-----------------|---|---|------------|
| — | — | — | .012 THK BERYLLIUM COPPER 1/2 HARD | ② |
| PART | ITEM | REQ'D | DESCRIPTION | FINISH |
| LIST OF MATERIAL | | | | |
| DRAFTSMAN DI PAOLA | DATE 8-18-72 | <div style="text-align: center;"> <h2>HEAT DISSIPATOR FOR R067 - TYPE PLASTIC TRANSISTOR</h2> </div> | | |
| CHECKER J. M. D. | 8/18/72 | | | |
| ENGINEER H. M. D. | 3/15/74 | | | |
| INSPECTION S. B. M. | 8-18-72 | | | |
| PRODUCTION J. M. D. | 3/15/74 | <div style="text-align: center;">  <p>IERC INTERNATIONAL ELECTRONIC RESEARCH CORPORATION <small>a corporate division of DYNACOR CORPORATION OF AMERICA Burbank, California 91507</small></p> </div> | | |
| APPROVED J. M. D. | 8/18/72 | SCALE 4:1 | <div style="display: flex; justify-content: space-between;"> <div> DRAWING NUMBER 8410-10 </div> <div> REV. C </div> </div> | |
| | | | CODE 98978 | INDEX: MFG |

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